Docket No. JCLA14528

Form 1595 REC 06-29-2005	U.S. Department of Commerce
1-31-92	Patent and Trademark Office
To the Honorable Assistant 483	its: Please record the attached
original documents or	
 Name of conveying party(ies): Wei-Zhe Wong Ching-Sung Yang Chih-Chen Cho Nature of conveyance: ☐ Merger ☐ Security Agreement ☐ Other ☐ Change of Name ☐ Reassignment Date(s) of execution: February 18, 2005. 	2. Name/address of receiving Party(ies): Powerchip Semiconductor Corp. No. 12, Li-Hsin Rd. I, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C. Add'l names of receiving parties
4. Date(s) of execution: February 18, 2005.	Attached? Yes No
 5. Application number(s) or patent number(s): If this documents is being filed together with a new application, the execution date of the application is February 18, 2005. A. Patent Application No. (s) B. Patent No. (s) 	
Additional numbers attached	? □ Yes ⊠ No
6. Name and address of party to whom Correspondence concerning document should be mailed:	7. Total No. of applications and patents involved: ONE(1)
J.C. Patents, Inc. 4 Venture, Suite 250 Irvine, CA 92618 (949) 660-0761	 8. Total fee (37 CFR §3.41): \$40.00 ☑ Enclosed ☐ Charge to Acct. No. 9. Total number of pages, including Cover sheet, attachments and document 3.
DO NOT USE THIS SPACE	
10. Statement and Signature: To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.	
<u>Jiawei Huang</u> Name of Person Signing Signature	1

06/28/2005 GT0N11 00000061 11158412

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PATENT REEL: 016716 FRAME: 0283

ASSIGNMENT

WHEREAS.

1. Wei-Zhe Wong

2. Ching-Sung Yang

3. Chih-Chen Cho

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: NON-VOLATILE MEMORY DEVICE AND MANUFACTURING METHOD AND OPERATING METHOD THEREOF

[] Filed: Serial No.

[x] Executed concurrently with the execution of this instrument

WHEREAS, Powerchip Semiconductor Corp.

of No. 12, Li-Hsin Rd. I, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

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Third Joint Inventor(if any): Chih-Chen Cho

RECORDED: 06/21/2005

ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s)

Signature: Nei-Zhe Nong

Date: Fel 18, 2015

Sole or First Joint Inventor: Wei-Zhe Wong

Signature: Amy Sung Jang

Date: Feb. 18, 2015

Second Joint Inventor(if any): Ching-Sung Yang

Signature: Ab-Clan Ab Date: Feb. 18, 2005

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